

Title (en)

Casing for a circuit board and circuit board component with tolerance compensation

Title (de)

Gehäuse für eine Leiterplatte und Leiterplatten-Baugruppe mit Toleranzausgleich

Title (fr)

Boîtier pour une plaquette et composants de plaquettes dotés d'une égalisation de la tolérance

Publication

EP 2023702 B1 20120104 (DE)

Application

EP 08104522 A 20080624

Priority

DE 102007037221 A 20070807

Abstract (en)

[origin: EP2023702A1] The housing has a housing unit with two integrated connectors arranged at a distance from each other. Each of the two connectors has connector-pins (18) overlapped inside the housing. The housing unit has two moving units, which are limited in relation to each other and which carries one of the two connectors. The two units are made of an inelastic plastic material in a ratio and the material bridge is made of an elastic elastomer material in a ratio.

IPC 8 full level

H05K 5/00 (2006.01)

CPC (source: EP)

H05K 1/18 (2013.01); **H05K 2201/10189** (2013.01); **H05K 2201/105** (2013.01)

Cited by

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Designated contracting state (EPC)

DE FR GB IT

DOCDB simple family (publication)

EP 2023702 A1 20090211; **EP 2023702 B1 20120104**; DE 102007037221 A1 20090212

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